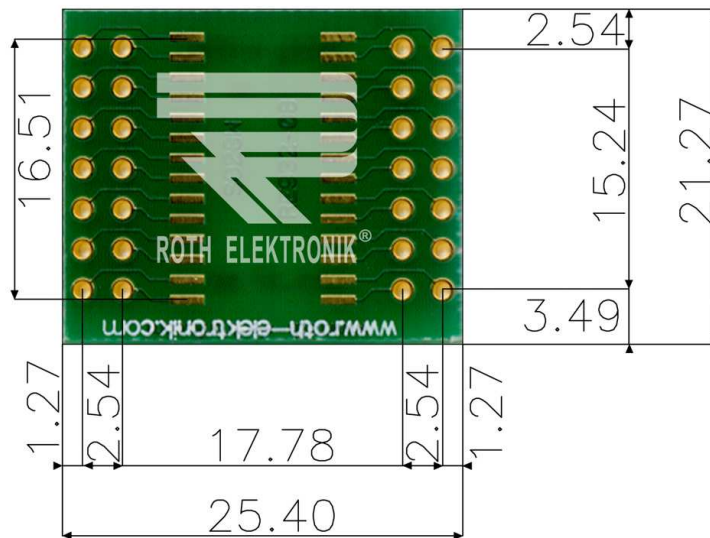


RE932-08

- Epoxy fibre-glass FR4 1.50 mm
 - Double-sided 35 µm Cu
 - Plated through holes (PTH)
 - Surface chem. Ni/Au with solder stop mask
 - Adaption circuit board for SO 28
 - Pitch: 1.27 mm (295 mil)
 - Hole diameter 1.00 mm
 - Size 21.27 x 25.40 mm
- Module-No. Pitch Pin Size (mm)

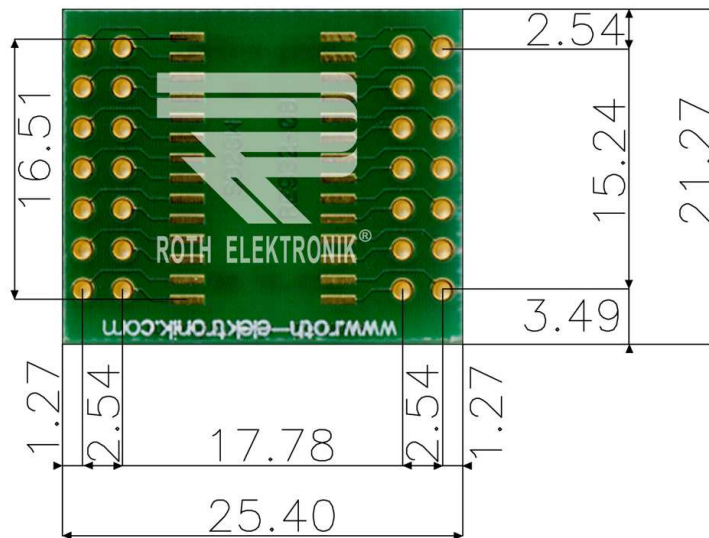
RE932-08 1.270 mm 0,50 28-w 7.50 (295 mil)



RE932-08

- Epoxydglashartgewebe FR4 1,50 mm
 - Zweiseitig 35 µm Cu
 - Durchkontaktiert (PTH)
 - Oberfläche chem. Ni/Au mit Lötstopplack beschichtet
 - Adaptionsplatine für SO 28
 - Pitch: 1,27 mm (295 mil)
 - Lochdurchmesser 1,00 mm
 - Größe 21,27 x 25,40 mm
- Modul-Nr. Pitch Pin Größe (mm)

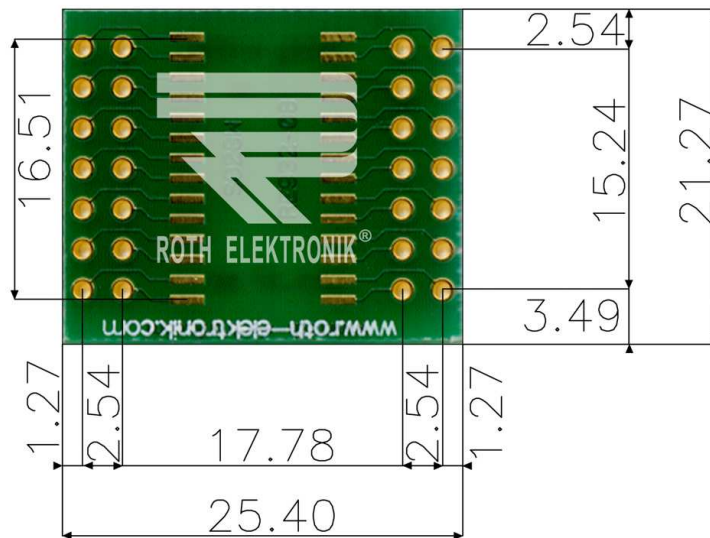
RE932-08 1,270 mm 0,50 28-w 7,50 (295 mil)



RE932-08

- Fibre de verre époxyde FR4 1,50 mm
 - Double face 35 µm CU
 - Métallisation des trous (PTH)
 - Surface avec Ni/Au chimique et un laque d'arrêt de soudure
 - Platine d'adaptation pour SO 28
 - Pitch: 1,27 mm (295 mil)
 - Perforation 1,00 mm Ø
 - Dimensions 21,27 x 25,40 mm
- Module-No. Pitch mil Pin Dimensions (mm)

RE932-08 1,270 mm 0,50 28-w 7,50 (295 mil)



RE932-08

- Fibra de vidrio epoxídica FR4 1,50 mm
 - Por dos lados 35 µm de Cu
 - Agujeros con contactos metalizados (PTH)
 - Superficie terminal química de Ni/Au y una máscara de inhibidora de la soldadura
 - Adaptador para SO 28-w
 - Pitch: 1,27 mm (295 mil)
 - Diámetro de agujeros 1,00 mm
 - Tamaño 21,27 x 25,40 mm
- Módulo-No. Pitch mil Pin Tamaño (mm)

RE932-08 1,270 mm 0,50 28-w 7,50 (295 mil)